Three Line EMI Filter

This device is a three-line EMI filter array for SIM Card wireless applications. Greater than -25 dB attenuation is obtained at frequencies from 800 MHz to 2.2 GHz. ESD protection is provided across all capacitors.

Features

- EMI Filtering and ESD Protection
- Integration of 10 Discretes
- Provides Protection for IEC61000-4-2 (Level 4)
 - ♦ 8.0 kV (Contact)
 - 15 kV (Air)
- Flip-Chip Package
- Moisture Sensitivity Level 1
- ESD Rating: Machine Model = C; Human Body Model = 3B
- Pb-Free Package is Available*

Benefits

- Reduces EMI/RFI Emissions on a Data Line
- Integrated Solution Offers Cost and Space Savings
- Reduces Parasitic Inductances Which Offer a More "Ideal" Low Pass Filter Response
- Integrated Solution Improves System Reliability

Applications

- SIM Card
- EMI Filtering and ESD Protection for Data Lines
- Cell Phones
- Handheld Products

	\mathbf{J} ($\mathbf{I}_{A} = 25$ C unless our	erwise note	;u)	
Rat	Rating		Value	Unit
ESD Discharge IEC61000-4-2	Air Discharge	V _{PP}	15	kV
IEC61000-4-2	Contact Discharge		8.0	
Steady-State Power p	er Resistor	P _R	100	mW
Steady-State Power p	er Package	PT	300	mW
Operating Temperature	e Range	T _{OP}	-40 to +85	°C
Storage Temperature F	Range	T _{STG}	-55 to +150	°C
Junction Temperature		TJ	+125	°C

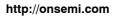
MAXIMUM RATINGS ($T_{\Delta} = 25^{\circ}$ C unless otherwise noted)

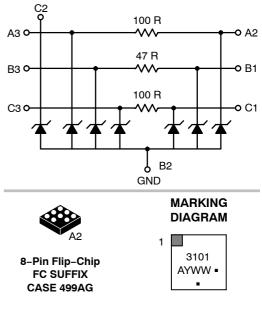
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



ON Semiconductor®

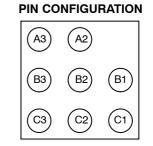






= Pb-Free Package

(Note: Microdot may be in either location)



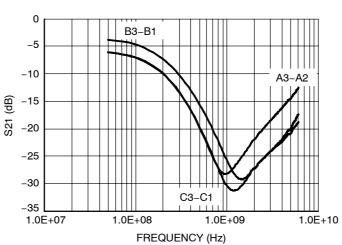
ORDERING INFORMATION

Device	Package	Shipping†
NUF3101FCT1	Flip-Chip	3000 Tape & Reel
NUF3101FCT1G	Flip–Chip (Pb–Free)	3000 Tape & Reel

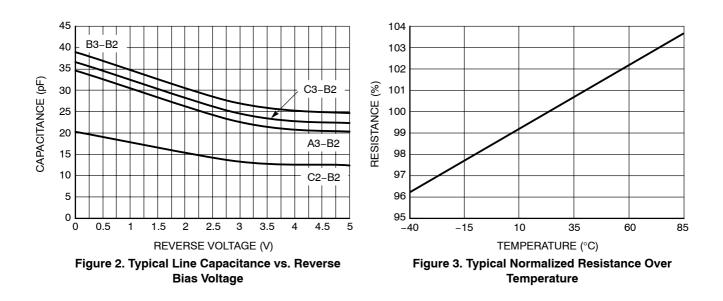
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Characteristic	Symbol	Test Conditions	Min	Тур	Max	Unit
Maximum Reverse Working Voltage	V _{RWM}	-	-	-	5.6	V
Breakdown Voltage	V _{BR}	I _R = 1.0 mA	6.0	-	8.0	V
Leakage Current	I _R	V _{RM} = 3.0 V	-	-	0.1	μΑ
Series Resistance	R ₁	_	80	100	120	Ω
Series Resistance	R ₂	_	38	47	56	Ω
Series Resistance	R ₃	_	80	100	120	Ω
Capacitance	C _{LINE 1}	f = 1.0 MHz, 0 Vdc	-	-	40	pF
Cut-Off Frequency	f _{3dB}	50 Ω Source and 50 Ω Load Termination	100	-	300	MHz

TYPICAL PERFORMANCE CURVES ($T_A = 25^{\circ}C$ unless otherwise specified)







PRINTED CIRCUIT BOARD RECOMMENDATIONS

Parameter	500 μm Pitch 300 or 350 μm Solder Ball
PCB Pad Size	250 μm +25 _0
Pad Shape	Round
Pad Type	NSMD
Solder Mask Opening	350 μm ±25
Solder Stencil Thickness	125 μm
Stencil Aperture	250 x 250 μm sq.
Solder Flux Ratio	50/50
Solder Paste Type	No Clean Type 3 or Finer
Trace Finish	OSP Cu
Trace Width	150 μm Max

Copper

Solder mask



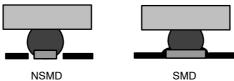


Figure 4. NSMD vs. SMD

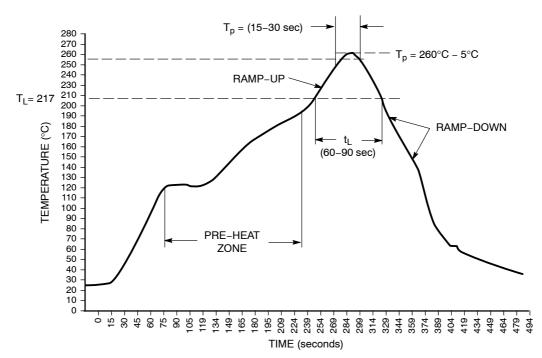
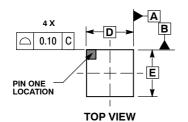
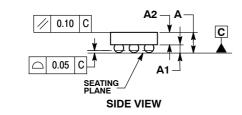


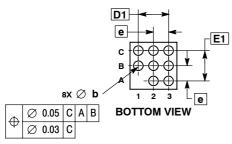
Figure 5. Typical Pb-Free Solder Heating Profile

PACKAGE DIMENSIONS

8 PIN FLIP-CHIP FC SUFFIX CASE 499AG-01 ISSUE A







NOTES:

 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

CONTROLLING DIMENSION: MILLIMETERS.
COPLANARITY APPLIES TO SPHERICAL

CROWNS OF SOLDER	BALLS.

	MILLIMETERS		
DIM	MIN MAX		
Α	0.70		
A1	0.210 0.270		
A2	0.380	0.430	
D	1.550 BSC		
E	1.550 BSC		
b	0.290 0.340		
е	0.500 BSC		
D1	1.000 BSC		
E1	1.000 BSC		

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